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# FGH40N60SMD 600 V, 40 A Field Stop IGBT

### Features

- Maximum Junction Temperature : T<sub>J</sub> = 175<sup>o</sup>C
- Positive Temperaure Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)}$  = 1.9 V(Typ.) @ I<sub>C</sub> = 40 A
- High Input Impedance
- Fast Switching: E<sub>OFF</sub> = 6.5 uJ/A
- Tighten Parameter Distribution
- RoHS Compliant

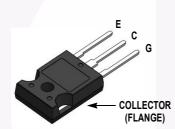
### Applications

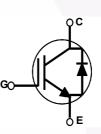
· Solar Inverter, UPS, Welder, PFC, Telecom, ESS

### October 2014

### **General Description**

Using novel field stop IGBT technology, Fairchild's new series of field stop 2<sup>nd</sup> generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.





### **Absolute Maximum Ratings**

Symbol	Description		Ratings	Unit
V <sub>CES</sub>	Collector to Emitter Voltage	600	V	
V <sub>GES</sub>	Gate to Emitter Voltage		± 20	V
	Transient Gate to Emitter Voltage		± 30	V
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25°C	80	A
'U	Collector Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	40	A
I <sub>CM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25°C	120	A
I <sub>F</sub>	Diode Forward Current	@ T <sub>C</sub> = 25°C	40	A
'F	Diode Forward Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	20	A
I <sub>FM (1)</sub>	Pulsed Diode Maximum Forward Cur	rent	120	A
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	349	W
. D	Maximum Power Dissipation	@ T <sub>C</sub> = 100 <sup>o</sup> C	174	W
TJ	Operating Junction Temperature		-55 to +175	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 secor	nds	300	°C

#### Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

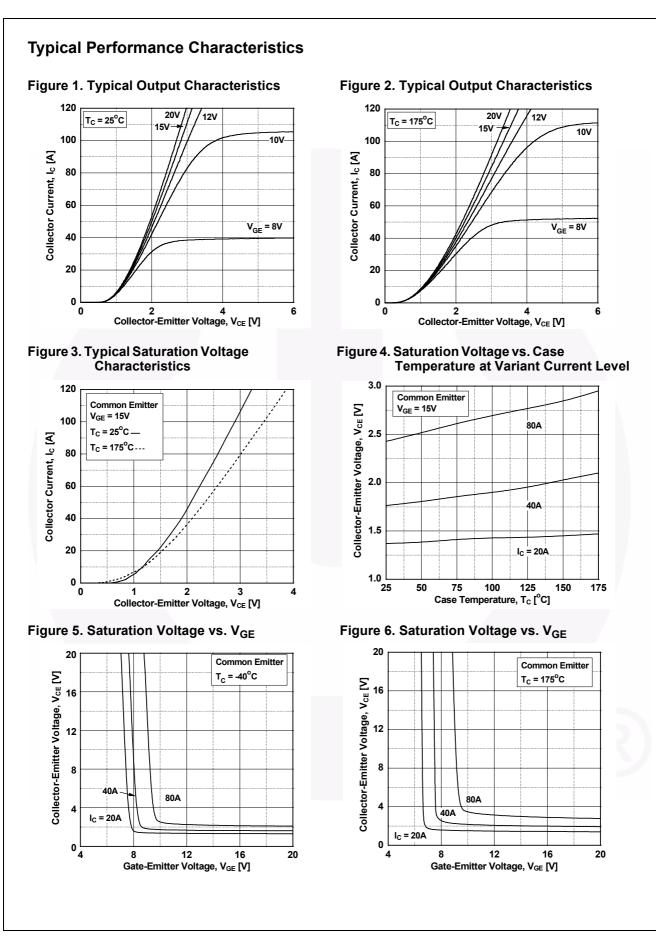
Symbo	I	Parameter				Тур.		Max.		Unit	
R <sub>0JC</sub> (IGBT)	Thern	nal Resistance, Junct	ise		-		0.43		°C/W		
R <sub>θJC</sub> (Diode) Thermal Resistance, Junction to Ca								1.5		°C/W	
R <sub>0JA</sub> Thermal Resistance, Junction to Am			nbient				40		°C/W		
Package	e Marki	ng and Order	ing In	form	ation		- I		-		
Part Number Top Mark Pack   FGH40N60SMD FGH40N60SMD TO-2				kage Packing Method		Reel Size		Tape Wid	th Qu	Quantity	
				N/A		N/A		30			
Electric	al Char	acteristics of	the lo	GBT	T <sub>C</sub> = 25°C unless othe	rwise noted					
Symbol		Parameter		Test Condition		ns Min		Тур.	Max.	Unit	
	Off Characteristics			V						V	
BV <sub>CES</sub> ∆BV <sub>CES</sub>		Collector to Emitter Breakdown Voltage			V <sub>GE</sub> = 0 V, I <sub>C</sub> = 250 μA			-	-	V	
$\Delta T_J$	Voltage	mperature Coefficient of Breakdown Itage			$V_{GE}$ = 0 V, I <sub>C</sub> = 250 $\mu$ A			0.6	-	V/ºC	
I <sub>CES</sub>	Collector (	lector Cut-Off Current			V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0 V			-	250	μA	
I <sub>GES</sub>	G-E Leaka	G-E Leakage Current			$V_{GE}$ = $V_{GES}$ , $V_{CE}$ = 0 V			-	± 400	nA	
On Charact	eristics										
V <sub>GE(th)</sub>	G-E Threshold Voltage			I <sub>C</sub> = 250 μA, V <sub>CE</sub> = V <sub>GE</sub>			3.5	4.5	6.0	V	
02(0)				-	A, V <sub>GE</sub> = 15 V		-	1.9	2.5	V	
V <sub>CE(sat)</sub>	CE(sat) Collector to Emitter Saturation Voltage			I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V, T <sub>C</sub> = 175°C			-	- 2.1		V	
Dynamic C	haracteris	tics							1		
C <sub>ies</sub>	Input Cap						-	1880	-	pF	
C <sub>oes</sub>	Output Capacitance Reverse Transfer Capacitance			V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V, f = 1 MHz			_	180	-	pF	
C <sub>res</sub>							-	50	-	pF	
	Charactori	stics								/	
Switching (		Delay Time					· ·	12	16	ns	
t <sub>d(on)</sub> t <sub>r</sub>	Rise Time						_	20	28	ns	
t <sub>d(off)</sub>		Delay Time		Voc =	400 V, I <sub>C</sub> = 40 A,		-	92	120	ns	
t <sub>f</sub>	Fall Time	,		$R_G = 6$	Ω, V <sub>GE</sub> = 15 V,		-	13	17	ns	
E <sub>on</sub>		Switching Loss		Inducti	ve Load, $T_C = 25^\circ$	°C	-	0.87	1.30	mJ	
E <sub>off</sub>		Switching Loss				-		0.26	0.34	mJ	
E <sub>ts</sub>		ching Loss					-	1.13	1.64	mJ	
t <sub>d(on)</sub>		Delay Time					-	15	-	ns	
t <sub>r</sub>	Rise Time						-	22	-	ns	
t <sub>d(off)</sub>	Turn-Off D	elay Time		$V_{CC} = $	400 V, I <sub>C</sub> = 40 A,	-		116	-	ns	
t <sub>f</sub>	Fall Time				R <sub>G</sub> = 6 Ω, V <sub>GE</sub> = 15 V,			16	-	ns	
E <sub>on</sub>	Turn-On S	Switching Loss		Inducti	ve Load, T <sub>C</sub> = 17	5°C	-	0.97	-	mJ	
E <sub>off</sub>	Turn-Off S	Switching Loss		1			-	0.60	-	mJ	
E <sub>ts</sub>	Tatal Curit	ching Loss		1			-	1.57	_	mJ	

## Electrical Characteristics of the IGBT (Continued)

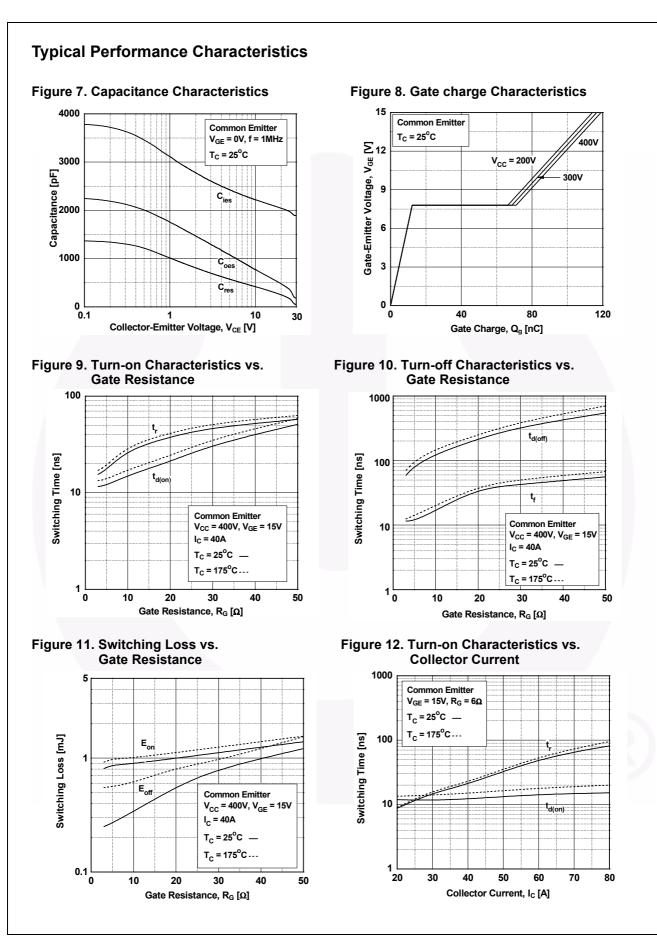
Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V	-	119	180	nC
Q <sub>ge</sub>	Gate to Emitter Charge		-	13	20	nC
Q <sub>gc</sub>	Gate to Collector Charge		-	58	90	nC

Electrical Characteristics of the Diode T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		Test Conditions			Min.	Тур.	Мах	Unit	
V <sub>FM</sub>	Diode Forward Voltage	۱ <sub>F</sub> = ۱	20 A		T <sub>C</sub> = 25°C	-	2.3	2.8	V	
					T <sub>C</sub> = 175 <sup>o</sup> C	-	1.67	-		
E <sub>rec</sub>	Reverse Recovery Energy				T <sub>C</sub> = 175 <sup>o</sup> C	-	48.9	-	uJ	
t <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>F</sub> =20 A, dI <sub>F</sub> /dt = 200 A/μs			T <sub>C</sub> = 25°C	-	36	-	ns	
		if -20 A, dif/dt - 20	20 Α, αι <sub>F</sub> /αι - 200 Α/μ3		T <sub>C</sub> = 175 <sup>o</sup> C	-	110	-		
Q <sub>rr</sub>	Diode Reverse Recovery Charge				T <sub>C</sub> = 25°C	-	46.8	-	nC	
~11	2.000 Hororor (000 for y charge				T <sub>C</sub> = 175 <sup>o</sup> C	-	445	-		

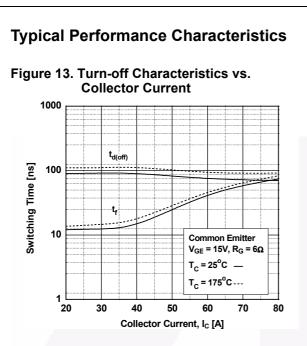


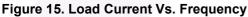
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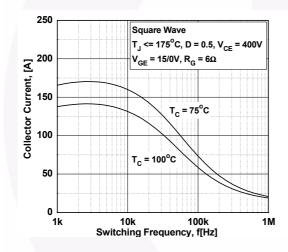
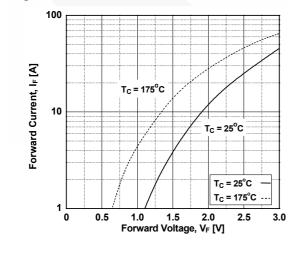
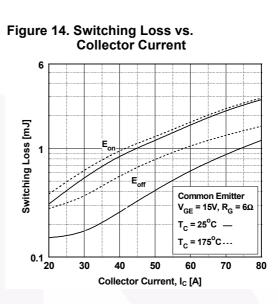


Figure 17. Forward Characteristics





**Figure 16. SOA Characteristics** 

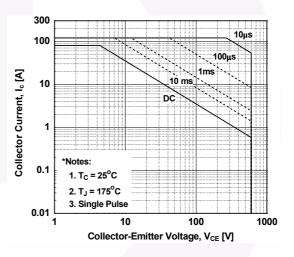
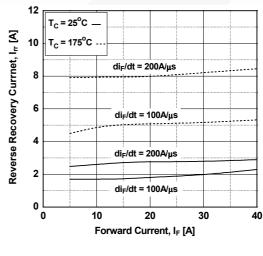
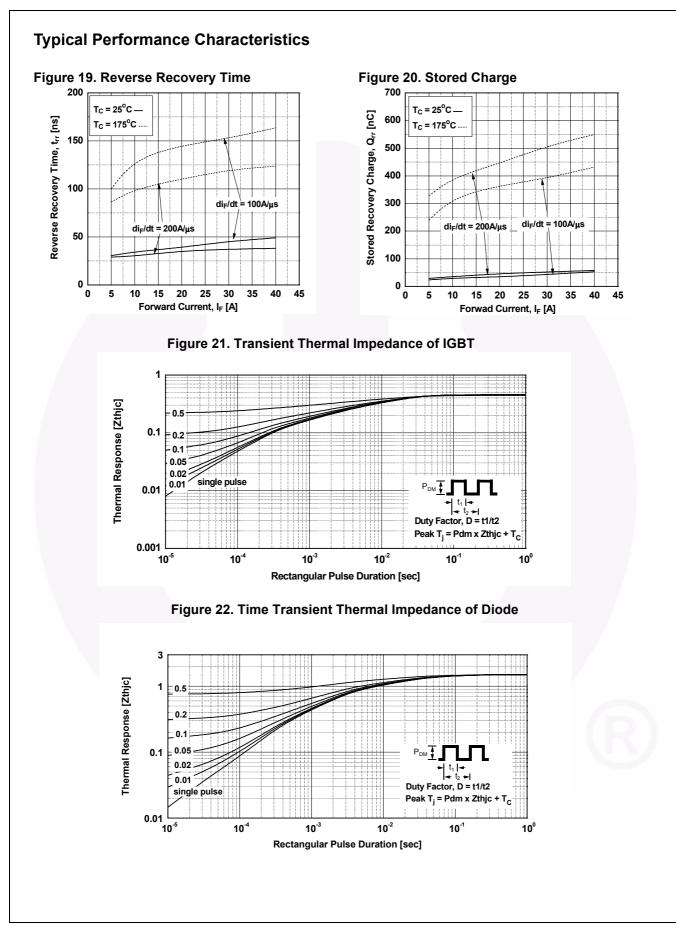
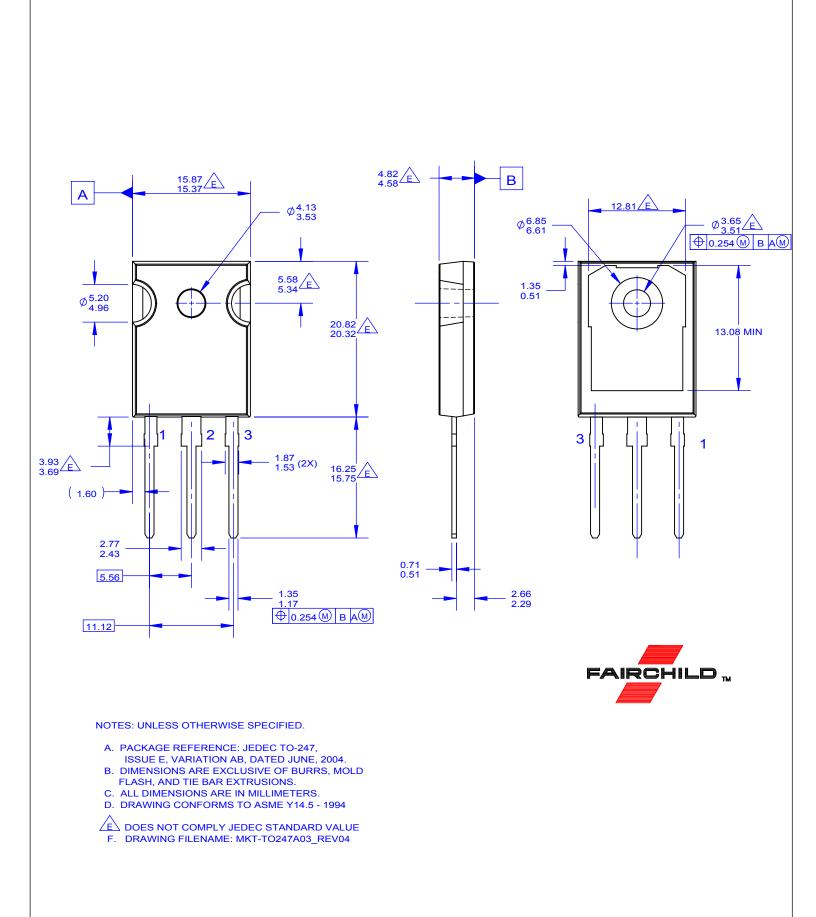


Figure 18. Reverse Recovery Current



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